



NOTES:

1. HATCH AREA IS SOLDERABLE EXPOSED PAD
2. BASED ON REF JEDEC # MO-248
3. PACKAGE WEIGHT: $38\text{mg} \pm 4 \text{ mg}$
4. ALL DIMENSIONS ARE IN MILLIMETERS

CYPRESS Company Confidential	
TITLE PACKAGE OUTLINE, 32L QFN 5X5X0.60 MM LQ32A 1.3X2.7 EPAD (SAWN TYPE)	
SPEC NO. 001-48913	REV *E
SCALE 1:1	SHEET 1 OF 2

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PACKAGE CODE(S)
 LQ32A

REV	ECN	Orlgn of Change	Description of Change
**	2567611	JSO	NEW RELEASE
*A	2577136	JSO	ADDED Y EPAD DIMENSION, CORRECTED SPEC TITLE
*B	2820496	TZWTMP3	CHANGE TEMPLATE, CHANGE TITLE FROM 32L QFN 5 X 5 X 0.55 MM PACKAGE OUTLINE 1.3 X 2.7 EPAD (SAWN TYPE) TO PACKAGE OUTLINE, 32L QFN 5X5X0.55 MM LQ32A 1.3X2.7 EPAD (SAWN TYPE)
*C	3745001	JSO	SUNSET REVIEW
*D	4105802	ROWI	SUNSET REVIEW, CHANGED DRAWING TEMPLATE
*E	6438310	KOTA	Change the title from 5x5x0.55mm to 5x5x0.60mm



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TITLE
PACKAGE OUTLINE, 32L QFN 5X5X0.60 MM LQ32A
1.3X2.7 EPAD (SAWN TYPE)

SPEC NO. 001-48913 REV *E

SCALE 1:1 SHEET 2 OF 2

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